Numerical treatment of floating conductors based on the traditional finite element formulation

David Rincón*,1, Ernesto Aguilera1 and Julio C. Chacón1

¹Department of electrical, electronics and telecommunications engineering, Universidad Industrial de Santander, Bucaramanga, Colombia *corresponding author, E-mail: david.rincon1@correo.uis.edu.co

Abstract

A method to model a conductor with undefined potential (commonly known as *floating conductor*), is sometimes required in the electric field analysis. This paper presents and compares the main methods to deal with such issue, based on the traditional finite element formulation. The purpose is to guide the reader in the selection of a method under the following criteria: Accuracy, implementation and simplicity. The accuracy of each method was evaluated against the analytic solution of the capacitance matrix for a system of parallel cylindrical conductors. Based on the results of the simulations, the characteristics of the methods and this paper's criteria, a qualification of each method performance is done. Additionally, particular cases in which a specific method could be the most suitable option to deal with floating conductors, are analyzed. In general, the Virtual Permittivity method exhibits the best performance. However, it is shown that the method's accuracy is influenced by the rounding errors. paper proposes an additional consideration on the method formulation in order to verify the accuracy of the results.

1. Introduction

The capacitance matrix [c] and the inductance matrix [l] are often required in the characterization of transmission lines and the analysis of printed circuit boards PCB, to study the electromagnetic compatibility and the electromagnetic interference of such systems [1]. In many cases, it is not possible to obtain an analytical solution for [c] and [l], due to complex geometries and materials. Therefore, numerical methods have an important role in the analysis of electric and magnetic fields. The Finite Element Method FEM is a powerful tool to solve the electric field distribution of multiconductor wire lines, PBC, multilayer structures, etc. [2, 3, 4]. An important feature of FEM, is that it enables to describe with great flexibility the geometry or the media of a given problem [2]. Hence, it is ideal to deal with complex materials and shapes.

In the electric field characterization, a method to model an isolated perfect conductor is sometimes required [5]. This topic has been object of study in many scientific papers [6, 7, 8]. An isolated conductor is usually known as a *floating conductor*, and it refers to the case in which the potential of the conductor is not defined. Although it constitutes an equipotential surface, the conductor cannot be defined by a Dirichlet boundary condition. Therefore, traditional FE solvers are not suitable to deal with floating conductors.

This paper presents different methods based on the traditional finite element FE formulation to deal with floating conductors in the electric field analysis [9]. The methods are compared based on their accuracy, implementation and simplicity. A short and detailed description of each method is presented. In order to evaluate the accuracy of the methods, the capacitance matrix of a system of parallel cylindrical conductors was estimated by each method and the results were compared with the analytical solution; the procedure to calculate the capacitance matrix is presented for each method. Based on the results of the simulations, the characteristics of the methods and this paper's criteria, a qualification of each method performance is done. Typically, the virtual permittivity method VPM is the preferred option to deal with floating potentials. However, in particular cases, another method could be the most suitable option due to its characteristics. Furthermore, it is shown that the VPM accuracy is influenced by rounding errors. For this reason, an additional consideration on the VPM formulation is proposed in order to avoid inaccurate results.

This paper is presented as follows: Section 2 presents the problem formulation for floating conductors. In section 3, the different methods to deal with floating conductors are described. Section 4 shows the analytical solution and the simulation results of [c] for a configuration of cylindrical conductors. In section 5, the performance of the methods is analyzed. Also, it is shown that the VPM is influenced by rounding errors. Therefore, additional considerations must be taken into account in the method formulation, to verify the accuracy of the results. Finally, the main conclusions are presented.

2. Framework

2.1. General Formulation

Fig. 1 shows the model of N perfect electric conductors (PEC) in an electrostatic field. Ω is the solution domain, Ω_C the domain of each conductor, Γ is the boundary of each domain with subscript i for $i=1,2,...,f,...,N,\Omega$ and $f\in i$ is the floating conductors subscript for f=1,2,...,M.

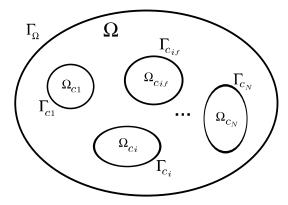


Figure 1: Model of a N conductors system [7].

The model is described by the electromagnetic set of equations presented in Eq.(1).

$$\begin{cases} \nabla \cdot \varepsilon \nabla \varphi = -\rho & in \ \Omega \\ \varphi_i = u_{0i} & in \ \Gamma_i \quad i = 1, 2, ..., N, \Omega \\ Q_f = q_{0f} & in \ \Gamma_f \quad f = 1, 2, ..., M \ (1) \\ \oint_{\Gamma_i} \varepsilon \frac{\partial \varphi}{\partial n} \, \mathrm{d}\Gamma = Q_i \quad in \ \Gamma_i \quad i = 1, 2, ..., N \end{cases}$$

Where φ is the potential function; ρ is the volume charge density; ε is the material permittivity. According to the electromagnetic theory, a PEC in the presence of an electrostatic field becomes an equipotential surface. If the equipotential value is known, a Dirichlet boundary condition $\varphi_i = u_{0i}$ is obtained and Ω_C may be excluded from the problem domain because the potential is constant throughout the conductor's volume. A *floating potential* is referred to the case when the u_0 value is unknown and it makes part of the solution [6, 10]. In addition, the charge of a PEC is redistributed in the presence of nearby charges due to the electrostatic induction. Nevertheless, law of charge conservation establishes that the initial charge in an isolated conductor must be the same before and after it is exposed to an electric field. Therefore, all the methods to deal with floating potentials are based on the following: A PEC represents an equipotential surface with unknown value and it also satisfies the law of charge conservation with $Q_i = q_{0i}$.

2.2. Capacitance Matrix Approach

The Capacitance Matrix Approach (CMA) is based on these principles, but it deals with floating conductors in an indirect way. This approach proposes to change the charge conditions of the system, instead of modeling the behavior of the floating conductor, in order to solve a problem with traditional Dirichlet boundary conditions. System of equations (2) shows the charges vector [Q] (for N conductors), in terms of the capacitance matrix [c] and the conductors voltage vector [V].

$$\begin{bmatrix} Q_1 \\ Q_2 \\ Q_3 \\ \vdots \\ Q_N \end{bmatrix} = \begin{bmatrix} c_{11} & c_{12} & c_{13} & \cdots & c_{1N} \\ c_{21} & c_{22} & c_{23} & \cdots & c_{2N} \\ c_{31} & c_{32} & c_{33} & \cdots & c_{3N} \\ \vdots & \vdots & \vdots & & \vdots \\ c_{N1} & c_{N2} & c_{N3} & \cdots & c_{NN} \end{bmatrix} \begin{bmatrix} V_1 \\ V_2 \\ V_3 \\ \vdots \\ V_N \end{bmatrix}$$

For each conductor, Q_i or V_i is set as a system condition. The other variable is unknown and it might be required as part of the solution. A floating conductor represents the case when Q_i is known and V_i is unknown. The CMA replaces the charge conditions Q_i by its respective u_{0i} , which only can be done if [c]'s values are known [11, 12]. It must be emphasized that [c] can be found by any of the proposed methods. However, only a few methods use the CMA to deal with floating potentials. The advantage of the CMA is that [c] contains all the information of the system, so if any voltage or charge condition is changed, [Q] and [V] can be obtained solving Eq.(2). For other parameters, like the potential or electric field distributions, a traditional FE with u_{0if} for i = 1, 2, ..., N must be performed. The drawback of this approach is that at least (N+1)/2 simulations are required to find [c]'s values. The reason is that using [c]'s symmetry, the number of unknown coefficients is N(N+1)/2; divided by N, which is the number of equations that can be obtained in each simulation for most of the methods, give the minimum number of simulations that must be performed to solve [c]. In this paper, a simulation will be referred to the process of finding [Q] for a given [V] or vice versa, using FEM.

3. Methods for Traditional FE Formulation

In this section, the traditional FE methods to deal with floating potentials are presented. A concise explanation of each method's formulation is given. Also, the main advantages and disadvantages of the methods are mentioned. For a detailed overview of each method, the corresponding references can be consulted.

3.1. Charge Representation

The Charge Representation Method (CRM) depicts the surface charge of a conductor as an equivalent charge distribution in the conductor's domain [7]. Equation (3) shows the charge of the conductor i.

$$Q_i = \sum_{k=1}^{nt} \rho_{ik} v_{ik} \tag{3}$$

Where ρ_{ik} is the charge density and v_{ik} is the volume for k=1,2,...,nt, with nt being the number of the finite elements in the conductor. The CRM can deal with charge conditions $Q_i \neq 0$ but it has several disadvantages. Firstly, it does not consider the conductor as an equipotential domain. Secondly, the method depends on the user's expertise to select the number and the location of the

simulated charges in order to model the *electrostatic* induction effect. Finally, there is an increase in the number of nodes due to the inclusion of Ω_C .

3.2. Homogeneous Boundary Condition

The Homogeneous Boundary Condition Method (HBCM) deals with floating conductors with $Q_f = 0$. This method consists of reducing the FE matrix based on the fact that the equipotential surface of a floating conductor constitutes a single variable with unknown value [10]. System of equations (4) shows the equivalent FE matrix equation to the Poisson's equation [9].

$$[S][\varphi] = [B]$$

$$b_{\hat{\iota}} = \sum_{k=1}^{at} \frac{\rho_k v_k}{en}$$

$$u_{\hat{\iota}} = -\sum_{j=1}^{an} S_{\hat{\iota}j} u_{0j}$$

$$(4)$$

Where $[\varphi]$ is the vector of unknown potentials, [S] is the overall stiffness matrix and [B] is a vector related to the initial conditions of voltage u_0 and to the charge distributions ρ_k . [B] is defined as [B] = [b] - [u]; Where [b] is related to the number of nodes en that conform the finite element, to the charge distribution ρ_k and to the volume v_k of the adjacent elements k to the node $\hat{\iota}$. [u] is related to the known potentials u_{0j} of the adjacent nodes j to the node $\hat{\iota}$.

The procedure for each floating conductor f, consist in selecting a reference node r that belongs to the boundary Γ_f to represent the unknown potential $\varphi_f = \varphi_r$. Once r is selected, the system is reduced in the following way: All the [S] rows that belong to Γ_f , are added to the S_r row and then these are removed from the matrix. In the same way, the [B] rows that belong to Γ_f are added to the B_r row and then are removed from the vector. Next, the same procedure is applied to the columns of [S] that belong to Γ_f . Once the reduced system is solved, $[\varphi]$ is reconstructed replacing $\varphi_{\Gamma_f} = \varphi_r$. A detailed explanation of this procedure is presented in [7]. The advantages of this method are that it guarantees accurate results, and the fact that the conductor domain Ω_C is excluded of the problem. On the other hand, the matrix reduction requires more computational resources. In addition, a traditional FE solver for the Poisson's equation can require modifications to perform the matrix reduction. Usually, the user does not want to deal with the FE package code because a major comprehension of the code and the capacity to modify it, are needed.

3.3. Virtual Permittivity

The Virtual Permittivity Method (VPM) consist in representing a PEC with $Q_f=0$, as an extreme form of dielectric material. The representation is accomplished by defining an infinite electric permittivity ε_{∞} for the conductor [10]. In the numerical approach, infinite means

"very large". The principal disadvantage of the VPM, consist in defining the value of ε_r in order to obtain accurate results [8]. Suggested ε_r values are among 10^5-10^7 [10, 13]. However, the selection of ε_r is not that simple as it is shown in section 5. Another drawback of this method is that Ω_C must be considered. Therefore, the number of nodes increases according to the mesh size and the geometry of the conductor.

3.4. Minimum Energy

The Minimum Energy Method (MEM) deals with the floating potentials using the CMA [13]. [c] is calculated based on the energy equation of the system [13]. Equation (5) shows the energy of the system W.

$$W = \frac{1}{2} \int_{\Omega} \varepsilon E^2 \, \mathrm{d}\Omega = \frac{1}{2} [V][c][V]' \tag{5}$$

The equation is given first in terms of the electric field E, and later in terms of the capacitance matrix [c] and the vector of the conductors voltages [V]. The MEM consist in performing N(N+1)/2 FE simulations, in which W is calculated using the E solution. Then based on the first and third part of Equ.(5), an equation system must be propose and solve. The simplest approach to find the self-capacitance coefficients c_{ii} , consists in perform N simulations in which all but one conductor are defined with a boundary condition $V_j = 0$ for $j \neq i$. Equation (6) defines c_{ii} coefficients for this approach.

$$c_{ii} = 2\frac{W_i}{V^2} \tag{6}$$

Where W_i is the system energy found in the simulation with potential $V_i \neq 0$. In the same sense, the boundary conditions $V_i \neq 0$, $V_j \neq 0$ and $V_k = 0$, for $k \neq i \land k \neq j$, can defined for the conductors in order to calculate the mutual-capacitance coefficients $c_{ij} = c_{ji}$ by Eq.(7).

$$c_{ij} = \frac{W_{ij} - 0, 5(c_{ii}V_i^2 + c_{jj}V_j^2)}{V_iV_j}$$
(7)

As it can be observed besides W_{ij} , the self-coefficients c_{ii} and c_{jj} are required to find mutual-coefficient c_{ij} . Although the number of simulations required for this method increases at a rate of N(N+1)/2, the calculation of W is simple once E is solved. Therefore, this method is useful when N has a low value.

3.5. Gauss Law

The Gauss Law Method (GLM) also calculates the capacitance matrix of the system, with a different procedure, in order to deal with floating potentials. In this case, as for most of the methods, an equation system based on Equ.(2) must be propose and solve. A simple procedure to solve [c] by the GLM, consists on performing N simulations in which the conductors are defined with a boundary condition $V_k = 0$ for $k \neq j$. Equation (8) is

solved by numerical integration to find the charge Q_i for i = 1, 2, ..., N in each conductor.

$$\oint_{s} \varepsilon \vec{E} \cdot \vec{ds} = \int_{\Omega_{C}} \rho \, d\Omega_{C} \tag{8}$$

Equation (9) calculates the capacitance coefficients c_{ij} for the proposed procedure.

$$c_{ij} = \frac{Q_{ij}}{V_i} \tag{9}$$

Where Q_{ij} is the charge of each conductor, due to the voltage excitation $V_j \neq 0$. Using the symmetry of [c] and choosing the right combination of voltage excitation, the number of simulations can be reduced to a minimum of (N+1)/2. In such case, the resulting equation system must be solved (instead of Eq.(9)), to calculate [c]. Although this method required fewer simulations than the MEM, the definition and the numerical integration of \oint_s could be an exhausting task, specially for multiple conductors and 3D geometries.

4. Simulations and results

To evaluate the accuracy of the proposed methods, the numerical solution and the analytical solution of [c] were compared with a configuration of parallel cylindrical conductors above ground. The test case is shown in Fig. 2 (not scaled).

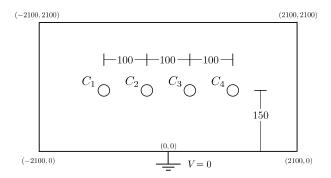


Figure 2: System of parallel cylindrical conductors. The radius of each conductor C_i is $r_i = 6$ for i = 1, 2, 3, 4

The distance between the center of each conductor and ground is 150, the distance between the center of two adjacent conductors is 100 and the radius of each conductor is r=6. Since traditional FE simulations were performed, the system of conductors was enclosed by a rectangle of 4200×2100 with V=0 to avoid significant errors. In addition, the number of nodes used in each simulation is $\simeq 5 \times 10^6$ in order to obtain reliable results. The simulations were performed on the *Partial Differential Equation* toolbox of Matlab. In the case of the HBCM, the matrices $[\mathbf{p}]$, $[\mathbf{e}]$ and $[\mathbf{t}]$, were imported from the toolbox to calculate matrices [B] and [S] [14]. Regarding the matrices, $[\mathbf{p}]$ contains the (x,y) coordinates of the nodes, $[\mathbf{e}]$ contains the information of the geometry's edges (used to set the

boundary conditions), and [t] contains the indices of the nodes that conform each element. The matrix calculation and the solution of [V], are done with a code developed on Matlab which performs the matrix reduction presented in section 3.2. The results are expressed in percent error between the analytical solution and the solution obtained by the corresponding method.

4.1. Analytical Solution

Fig. 3 shows a general model for N parallel conductors above ground with their respective image conductors. Where H is the distance between the conductor's center and ground, x_{ij} and y_{ij} are the horizontal and the vertical distances between the conductors i and j, respectively, for i=1,2,...,N and j=1,2,...,N.

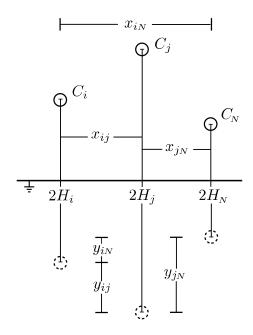


Figure 3: Model of parallel conductors and their image.

Maxwell's Potential Coefficient Method is used to calculate the analytical value of [c], given by Eq.(10).

$$[c] = 2\pi\varepsilon_0 \begin{bmatrix} \ln\left(\frac{I_{11}}{A_{11}}\right) & \ln\left(\frac{I_{12}}{A_{12}}\right) & \dots & \ln\left(\frac{I_{1j}}{A_{1j}}\right) \\ \ln\left(\frac{I_{21}}{A_{21}}\right) & \ln\left(\frac{I_{22}}{A_{22}}\right) & \dots & \ln\left(\frac{I_{2j}}{A_{2j}}\right) \end{bmatrix} \xrightarrow{F} m$$

$$\vdots \qquad \vdots \qquad \vdots \qquad \vdots \qquad \vdots$$

$$\ln\left(\frac{I_{i1}}{A_{i1}}\right) & \ln\left(\frac{I_{i2}}{A_{i2}}\right) & \dots & \ln\left(\frac{I_{ij}}{A_{ij}}\right) \end{bmatrix}$$

$$(10)$$

Where:

$$I_{ij} = \begin{cases} x_{ij}^{2} + (2H_{i} - r_{i} + y_{ij})^{2} & i \neq j \\ 2H_{i} - r_{i} & i = j \end{cases}$$

$$A_{ij} = \begin{cases} (r_{i} + y_{ij})^{2} & i \neq j \\ r_{i} & i = j \end{cases}$$

The method treats the system of conductors as a multi-line charge system under the assumption that the surface charges are uniformly distributed around each conductor. This assumption can be made if $H \gg r$. Nevertheless, r must be considered in [c]'s calculation to obtain an accurate expression [15, 16, 17]. The analytical solution of [c] for the test case is shown in Eq.(11).

$$[c] = \begin{bmatrix} 15,70223 & -4,21796 & -0,96158 & -0,45447 \\ -4,21796 & 16,82211 & -3,98749 & -0,96158 \\ -0,96158 & -3,98749 & 16,82211 & -4,21796 \\ -0,45447 & -0,96158 & -4,21796 & 15,70223 \end{bmatrix} \frac{pF}{m}$$
(11)

4.2. Charge Representation

Based on the CRM, [c] can be found with N simulations as follows: All the conductors will have an initial charge Q_{ik} , where i=1,2,...,N is the subscript of the conductor and k=1,2,...,N is the subscript of the simulation. The voltages V_{jk} are found in each simulation k for j=1,2,...,N. Finally, Eq.(12) shows the form of the N sets of equations for i=1,2,...,N that must be solved, in order to find the capacitance coefficients c_{ij} .

$$\begin{bmatrix} Q_{i1} \\ Q_{i2} \\ \vdots \\ Q_{ik} \\ \vdots \\ Q_{iN} \end{bmatrix} = \begin{bmatrix} V_{11} & V_{21} & \cdots & V_{j1} & \dots & V_{N1} \\ V_{12} & V_{22} & \cdots & V_{j2} & \dots & V_{N2} \\ \vdots & \vdots & & \vdots & & \vdots \\ V_{1k} & V_{2k} & \cdots & V_{jk} & \dots & V_{Nk} \\ \vdots & \vdots & & \vdots & & \vdots \\ V_{1N} & V_{2N} & \cdots & V_{jN} & \dots & V_{NN} \end{bmatrix} \begin{bmatrix} c_{i1} \\ c_{i2} \\ \vdots \\ c_{ij} \\ \vdots \\ c_{iN} \end{bmatrix}$$

$$\begin{bmatrix} c_{i1} \\ c_{i2} \\ \vdots \\ c_{ij} \\ \vdots \\ c_{iN} \end{bmatrix}$$

$$(12)$$

In the test case, a constant charge density ρ through the domain of the conductors was considered. Therefore, $Q_{ik}=\pi r^2\rho_{ik}$. The [c] value obtained by the CRM in percent error rate against the analytical solution, is shown in Eq.(13).

$$[e\%] = \left[\begin{array}{cccc} 0,89536 & 0,81169 & 0,72452 & 2,60606 \\ 0,81200 & 0,88222 & 0,83315 & 0,72461 \\ 0,75538 & 0,83343 & 0,88220 & 0,81172 \\ 2,60676 & 0,72547 & 0,81202 & 0,89543 \end{array} \right] \tag{13}$$

4.3. Homogeneous Boundary Condition

The proposed procedure to find [c] by the HBCM, consist in defining the conductors with $Q_{jk}=0$ for $j\neq i$,

where k is the subscript of the simulation. In this way, for each simulation k a conductor ik is defined with an initial condition V_{ik} . Thus, the variables that must be found in each simulation k are the charge Q_{ik} and the voltages V_{jk} for j=1,2,...,N. To find Q_{ik} , Equ.(8) can be used. However, if it is convenient, Q_{ik} 's equation can be replace by Equ.(5) in each simulation. This is useful for the cases in which calculating the system energy W is easier than calculating the charge Q_{ik} . For k=N simulations, Eq.(14) shows the form of the N sets of equations for i=1,2,...,N, that must be solved to find [c].

$$\begin{bmatrix} 0 \\ 0 \\ \vdots \\ Q_{ik} \\ \vdots \\ 0 \end{bmatrix} = \begin{bmatrix} V_{11} & V_{21} & \cdots & V_{j1} & \dots & V_{N1} \\ V_{12} & V_{22} & \cdots & V_{j2} & \dots & V_{N2} \\ \vdots & \vdots & & \vdots & & \vdots \\ V_{1k} & V_{2k} & \cdots & V_{jk} & \dots & V_{Nk} \\ \vdots & \vdots & & \vdots & & \vdots \\ V_{1N} & V_{2N} & \cdots & V_{jN} & \dots & V_{NN} \end{bmatrix} \begin{bmatrix} c_{i1} \\ c_{i2} \\ \vdots \\ c_{ij} \\ \vdots \\ c_{iN} \end{bmatrix}$$

The [c] value obtained by the HBCM percent error rate, is shown in Eq.(15).

$$[e\%] = \begin{bmatrix} 0,05467 & -0,55531 & -1,18893 & 1,40067 \\ -0,55538 & -0.09266 & -0,43767 & -1,18938 \\ -1,18893 & -0,43767 & -0,09265 & -0,55560 \\ 1,40067 & -1,18938 & -0,55560 & 0,05438 \end{bmatrix}$$
 (15)

4.4. Virtual Permittivity

The same procedure for the HBCM can be used to calculate [c] with the VPM. The relative permittivity used in the simulations was $\varepsilon_r = 1 \times 10^7$. The [c] value obtained by the VPM in percent error rate, is shown in Eq.(16).

$$[e\%] = \begin{bmatrix} 0,05465 & -0,55449 & -1,18787 & 1,40198 \\ -0,55449 & -0.09250 & -0,43652 & -1,18809 \\ -1,18787 & -0,43652 & -0,09243 & -0,55416 \\ 1,40198 & -1,18809 & -0,55416 & 0,05477 \end{bmatrix}$$

$$(16)$$

4.5. Minimum Energy

The procedure to find [c] by the MEM is explained in section 3.4. The [c] value obtained by the MEM in percent error rate, is shown in Eq.(17).

$$[e\%] = \begin{bmatrix} 0,05327 & -0,55670 & -1,19041 & 1,39949 \\ -0,55670 & -0,09410 & -0,43916 & -1,19058 \\ -1,19041 & -0,43916 & -0,09408 & -0,55676 \\ 1,39949 & -1,19058 & -0,55676 & 0,05323 \end{bmatrix} \tag{17}$$

4.6. Gauss Law

The procedure to find [c] by the GLM is explained in section 3.5. The [c] value obtained by the GLM in percent error rate, is shown in Eq.(18).

$$[e\%] = \begin{bmatrix} 0,06195 & -0,56717 & -1,24244 & 1,25028 \\ -0,56578 & -0,08734 & -0,44673 & -1,24268 \\ -1,24385 & -0,44422 & -0,08852 & -0,56789 \\ 1,24804 & -1,24476 & -0,56717 & 0,06068 \end{bmatrix}$$

4.7. Accuracy Analysis

Table.1 shows the RMS error between the analytical solution and each method for the test case. Also, it present the maximum error obtained in each case.

Table 1: RMS error and maximum error between the methods and the analytical solution.

| Method | RMS | Max. Error | |
|--------|-------------------------|-------------------------|--|
| CRM | $7,540 \times 10^{-14}$ | $1,484 \times 10^{-13}$ | |
| HBCM | $1,589\times10^{-14}$ | $2,343 \times 10^{-14}$ | |
| VPM | $1,586 \times 10^{-14}$ | $2,339 \times 10^{-14}$ | |
| MEM | $1,594 \times 10^{-14}$ | $2,348 \times 10^{-14}$ | |
| GLM | $1,616 \times 10^{-14}$ | $2,395 \times 10^{-14}$ | |

Except for the CRM, the results indicate that all methods are a suitable option to approximate the capacitance matrix [c]. The CRM presents the highest error order. This fact highlights the importance of a good representation of the charge distributions, even for simple geometries. For this reason, the basic formulation of this method is not recommended to deal with floating potentials.

5. Selection of a Method

The idea of this paper is to guide the reader in the selection of a method to deal with floating potentials. However, this is not a simple task. First, the performance of each method is influenced by several aspects such as its accuracy, computational resources, grid size, the user's expertise, etc. If all these aspects were considered in the comparison of methods for each particular problem (homogeneous or not homogeneous materials, complex or simple geometries, low or high number of conductors, etc.), the selection would be almost impossible. Additionally, different modifications could be made in the formulation of each method in order to improve its performance. For these reasons, this paper only considers the basic formulation of the methods, and the comparison is made based just on the accuracy, simplicity and implementation of each method. The method's qualification according to its characteristics (shown in section 2), the results of simulations and this paper's criteria, are shown in Table.2. The qualification is done from 1 to 5, being 5 the best rating. For instance, the VPM formulation is the easiest to understand and to implement. Therefore, it obtains 5 in simplicity and implementation. Regarding the accuracy parameter, most of the methods show similar results. Nevertheless, the HBCM obtain 5 because once it is implemented, it is the most reliable of the 5 methods. This means that the chances of inaccurate results due to a wrong selection of a parameter or a miscalculation, are the lowest. On the other hand, the traditional formulation of the VPM obtain 4 because its accuracy is highly influenced by the value of ε_r that is chosen (as it is discussed later on this section).

Table 2: Methods qualification.

| Method | Simplicity | Accuracy | Implementation |
|--------|------------|----------|----------------|
| CRM | 4,5 | 3,5 | 3,5 |
| HBCM | 4,5 | 5 | 3,5 |
| VPM | 5 | 4 | 5 |
| MEM | 4 | 4,5 | 4 |
| GLM | 4 | 4,5 | 4 |

The next point to be treated, is the cases in which a specific method is the most suitable option. For instance, the only method presented in this paper that can deal directly with initial conditions $Q_i \neq 0$, is the CRM. Nevertheless, the accuracy of this method depends on the representation of the charge distributions (main conclusion of section 4). As these are usually unknown, the CRM is not recommended to deal with floating potentials. Therefore, the recommended way to deal with initial conditions $Q_i \neq$ 0, is to calculate the matrix [c]. All methods can perform this task. However, the MEM is recommended for problems with a low number of conductors (N < 3). The reason is that the MEM presents the simplest procedure to find Still, the required number of simulations for the MEM increases at a rate of N(N+1)/2, which is a problem. In addition, if the electric field or the voltage distributions are desired, an extra simulation is required for all the methods based on the CMA (which is the case of the MEM). Therefore, if N value is too high, the remaining options are the HBCM, the VPM and the GLM. The procedure to find [c] is very similar for these methods, thus the selection depends on the user's ability to implement each method. Another important case, is when the matrix [c] is not required and the initial charge of the floating conductors is $Q_j = 0$. For this case, the MEM and the GLM are viable options only if $N \leq 3$. Otherwise, the selection must be made between the HBCM and the VPM. In general, these two methods are the best options to deal with floating potentials. The HBCM is a simple method that guarantees the accuracy of the results. However, modifications to the FE package may be required in order to implement it. If the FE package contains this

feature or the user can modify the package code, the HBCM should be selected. Often, none of these conditions is met. Therefore, the recommended option to deal with floating is the VPM. The main issue with the VPM, is to define the value of ε_r for the floating conductors. A study of how this parameter affects the accuracy of the method, was performed. The first step consisted of the 2D simulation of a parallel plates configuration, as shown in Fig. 4a, with a floating conductor in the middle of the plates. To consider the effect of the geometry, size and position of the floating conductor, six geometries were simulated (see Fig. 4). The location of the floating conductor is given in terms of the coordinates of the representative points of each geometry.

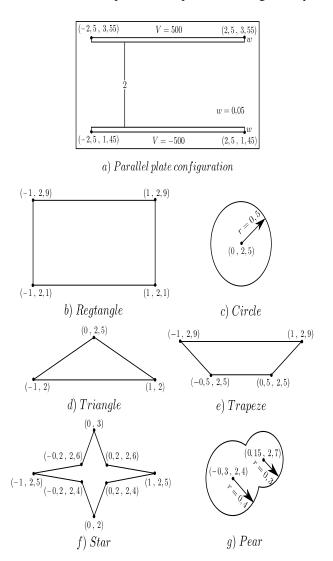


Figure 4: Parallel plate configuration and geometries used in the simulations.

For each case, simulations were performed with $\varepsilon_r=10^m$ for m=1,2,...,25. As it guarantees accuracy, the results were compared with the HBCM solution. Fig. 5 shows the magnitude of the maximum potential φ error between HBCM and the VPM, for the different ε_r 's values. It can be observed that the error order changes with the

geometry and the ε_r value. Nevertheless, the error has the same behavior for all geometries: The initial error decreases when the ε_r value is increased. It reaches a minimum at certain ε_r value that depends on the geometry. After this, if the ε_r value is increased, the error also increases until a local maximum is reached. The problem is that in some cases, the maximum is equal or higher than the value of the initial error (up to a $\simeq 10\%$ of the voltage applied to the plates).

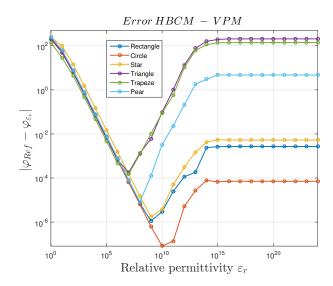
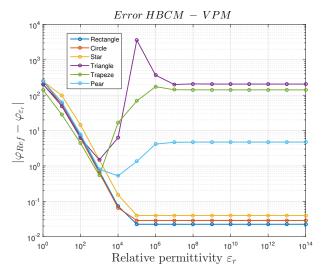
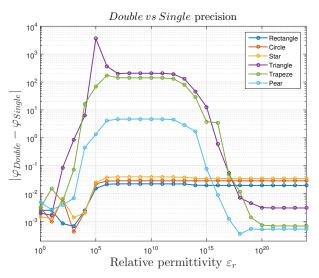


Figure 5: Maximum φ error between the HBCM and the VPM (with precision type Double), for the different ε_r 's values .

Based on the error behavior, it is proposed that the method's accuracy is affected by the rounding error. To verify this hypothesis, simulations for the same geometries were performed with precision type single instead of double. The results are shown in Fig. 6. In Fig. 6a, the results with single precision are compared with the HBCM. As it can be observed, the error behavior is very similar to the double precision case (Fig. 5). However, a critical peak value is presented before the error stabilizes for the triangle geometry. This is an additional reason why the selection of ε_r should not be taken lightly. The difference in the VPM results, for the precision types: double and single, are shown in Fig. 6b. It can be observed that the rounding error hypothesis is proved. For low values of ε_r , both precision types present similar results (error $\leq 10^{-1}$). Due to the fact that the *single* precision works with fewer significant figures, it is affected early by the rounding error. For this reason, a significant difference between the results can be obtained for certain values of ε_r . However, as ε_r 's value increases, both precision types will be affected by the rounding error. Therefore, at some point both precision types should have similar results; As it is shown in Fig. 6b. In this case, an error $\leq 10^{-1}$ is obtained for an $\varepsilon_r \geq 10^{19}$.



(a) Maximum φ error between the HBCM and the VPM, with precision type Single.



(b) Maximum φ error between the VPM with precision types *Double* and *Single*.

Figure 6: Results for the VPM with *Single* precision, for the different ε_r 's values.

Due to the rounding error, the selection of ε_r is not a simple task. If ε_r is too high, the rounding issue can lead to inaccurate results. Similarly, inaccurate results can be obtained for a low value of ε_r . Trying to find the optimal ε_r value will be inefficient, because it changes with the geometry of the problem. The most important point is to guarantee that the results are not affected by the rounding errors. The solution to this issue is to verify that the condition $Q_f=0$, is ensured. Fig. 7 shows the calculated charge by numerical integration of Eq.(8), for the different geometries with *double* precision.

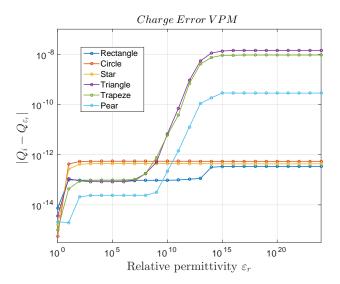


Figure 7: Charge error for the VPM for different ε_r .

The results indicate that the charge error is linked to the potential error caused by the rounding error. Taking this into account, this paper proposes that if the VPM is implemented, the following conditions must be ensured: $\varepsilon_r \gg 1$ and $Q_f \simeq 0$. The value of ε_r is defined by the user. Therefore, the problem is to define the criterion to assume $Q_f \simeq 0$ since the charge order depends on the voltage and the geometry of the source conductors. The source conductors charge Q_{si} can be found by Eq.(8). However, this will imply to calculate Q_i for all conductors. As an alternative to estimate Q_{si} order, the capacitance formulas of known geometries that represent the source conductors could be used. For the case study, the estimates are shown in Table. 3. Although the values differ, the charge order is correctly estimated. On each plate Q_s order is 10^{-8} , so a criterion to assume $Q_f \simeq 0$ can be $Q_f \leq 1 \times 10^{-12}$.

Table 3: Top plate charge estimation.

| Method | Formula | Charge Q |
|--|---------------------------------------|------------------------|
| Gauss Law | _ | $2,5\times10^{-8}$ |
| Infinite Parallel Plates | $C = \frac{\varepsilon_0 A}{d}$ | $1,107 \times 10^{-8}$ |
| Rectangular Parallel Plates [18] | $C = 2, 6 \frac{\varepsilon_0 A}{d}$ | $2,878 \times 10^{-8}$ |

6. Discussion

Although the VPM is recommended to deal with floating conductors, there are cases in which a specific method is the most suitable option. Even analytical solutions, which often are used to calibrate the numerical methods, could be

the right choice. This will depend on the features of the problem, the characteristics of the method and the user's expertise. For instance, if the matrix reduction can be easily performed, the HBCM should be selected above the VPM. Moreover, expert users can try advanced methods like the one proposed in [8]. Also, advanced formulations of the proposed methods could be tried. For example: improving the HBCM to deal with $Q_{if} \neq 0$, could be an option.

7. Conclusions

Different methods to deal with floating conductors, were studied. Based on their characteristics, the results of the simulations and this paper's criteria, each method performance was qualified (see Table. 2). In general, the *Virtual Permittivity method* shows the best performance. Nevertheless, it is shown that the method's accuracy is influenced by the rounding errors. Therefore, additional considerations in the method formulation are proposed in order to guarantee accurate results.

Acknowledgement

The authors would like to thank the Universidad Industrial

de Santander UIS for providing the computational resources for this research.

References

- [1] C. R. Paul, *Introduction to Electromagnetic Compatibility*. Wiley-Interscience, 2006.
- [2] H. D. Bruns, C. Schuster, and H. Singer, "Numerical electromagnetic field analysis for emc problems," *IEEE Transactions on Electromagnetic Compatibility*, vol. 49, no. 2, pp. 253–262, May 2007.
- [3] K. Hollaus, O. Biro, P. Caldera, G. Matzenauer, G. Paoli, and G. Plieschnegger, "Simulation of crosstalk on printed circuit boards by fdtd, fem, and a circuit model," *IEEE Transactions on Magnetics*, vol. 44, no. 6, pp. 1486–1489, June 2008.
- [4] B. Zhu, J. Lu, M. Zhu, and M. Jiang, "Arbitrary shape multilayer interconnects emc modelling and optimization," in 2015 10th International Workshop on the Electromagnetic Compatibility of Integrated Circuits (EMC Compo), Nov 2015, pp. 87–91.
- [5] S. Stadler, M. Albach, H. Robmanith, and G. Schubert, "The influence of ground and floating planes on the electromagnetic coupling between board tracks," in 2006 17th International Zurich Symposium on Electromagnetic Compatibility, Feb 2006, pp. 344–347.
- [6] W. N. Fu, S. L. Ho, S. Niu, and J. Zhu, "Comparison study of finite element methods to deal with floating conductors in electric field," *IEEE Transactions on Magnetics*, vol. 48, no. 2, pp. 351–354, Feb 2012.

- [7] W. Dong, R. Jiangjun, D. Zhiye, L. Shoubao, and Z. Yujiao, "Parallel numerical computing of finite element model of conductors and floating potentials," in *International Symposium on Parallel* and Distributed Processing with Applications, Sept 2010, pp. 57–61.
- [8] G. Aiello, S. Alfonzetti, S. A. Rizzo, and N. Salerno, "Fem-dbci solution of open-boundary electrostatic problems in the presence of floating potential conductors," *IEEE Transactions on Magnetics*, vol. 52, no. 3, pp. 1–4, March 2016.
- [9] R. F. P. Silvester, *Finite elements for electrical engineers*. Cambridge University Press, 1996.
- [10] A. Konrad and M. Graovac, "The finite element modeling of conductors and floating potentials," *IEEE Transactions on Magnetics*, vol. 32, no. 5, pp. 4329–4331, Sep 1996.
- [11] G. J. Cokkinides, B. Beker, and A. Templeton, "Direct computation of capacitance in integrated passive components containing floating conductors," *IEEE Transactions on Components, Packaging, and Manufacturing Technology: Part B*, vol. 20, no. 2, pp. 123–128, May 1997.
- [12] C. N. Dorny and R. A. Mathias, "Finite-difference methods for determining capacitance relationships among arbitrarily shaped conductors," *IEEE Transactions on Power Apparatus and Systems*, vol. PAS-90, no. 2, pp. 876–881, March 1971.
- [13] A. Konrad and M. Graovac, "The floating potential approach to the characterization of capacitive effects in high-speed interconnects," *IEEE Transactions on Magnetics*, vol. 33, no. 2, pp. 1185–1188, Mar 1997.
- [14] Partial Differential Equation ToolboxTM User's Guide. MathWorks Inc., 2017.
- [15] R. D. Begamudre, *Extra High Voltage ac Transmission Engineering (third edition)*, P. New age international (p) limited, Ed. New age international publisher, 2006.
- [16] M. P. Sarma and W. Janischewskyj, "Electrostatic field of a system of parallel cylindrical conductors," *IEEE Transactions on Power Apparatus and Systems*, vol. PAS-88, no. 7, pp. 1069–1079, July 1969.
- [17] Q. Li, R. Shuttleworth, G. Zhang, S. M. Rowland, and R. S. Morris, "On calculating surface potential gradient of overhead line conductors," in *Electrical Insulation (ISEI), Conference Record of the 2012 IEEE International Symposium on*, June 2012, pp. 540–544.
- [18] P. Benedek and P. Silvester, "Capacitance of parallel rectangular plates separated by a dielectric

sheet," *IEEE Transactions on Microwave Theory and Techniques*, vol. 20, no. 8, pp. 504–510, Aug 1972.